

REVISIONS			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Add device type 02 (AD571)	87-12-01	R. P. Evans
B	Make corrections to terminal connections. Make corrections to digital input high current and digital input low current test units. Make corrections to power supply rejection test conditions. Make corrections to switching waveforms. Add MIL-M-38510 information to 6.2 and 6.6. Make correction to three-state leakage current test units. Editorial changes throughout.	90-06-04	M. A. Frye
C	Add device type 03. Editorial changes throughout.	97-02-10	R. Monnin
D	Drawing updated to reflect current requirements. -rrp	03-02-07	R. Monnin
E	Modify drawing to current requirements. -rrp	10-10-20	C. Saffle

CURRENT CAGE CODE 67268

THE ORIGINAL FIRST SHEET OF THIS DRAWING HAS BEEN REPLACED.

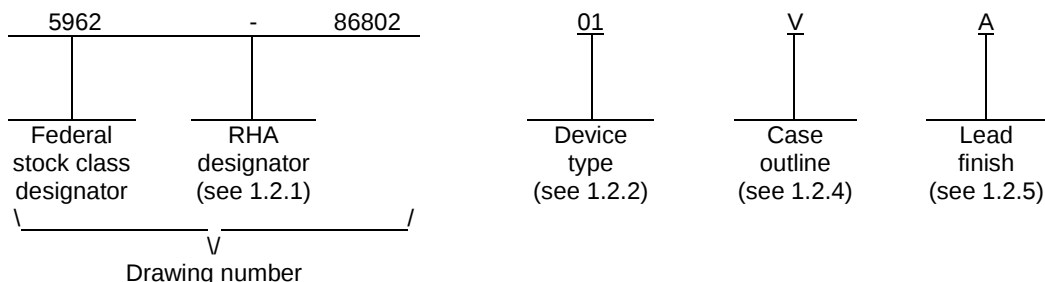
REV																				
SHEET																				
REV																				
SHEET																				
REV STATUS				REV		E	E	E	E	E	E	E	E	E	E	E				
OF SHEETS				SHEET		1	2	3	4	5	6	7	8	9	10	11				
PMIC N/A				PREPARED BY Donald R. Osborne					DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990 http://www.dsc.dla.mil											
STANDARD MICROCIRCUIT DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A				CHECKED BY D.A. Di Cenzo																
				APPROVED BY Nelson Hauck																
				DRAWING APPROVAL DATE 87-04-17																
				REVISION LEVEL E					SIZE A	CAGE CODE 14933		5962-86802								
										SHEET 1 OF 11										

1. SCOPE

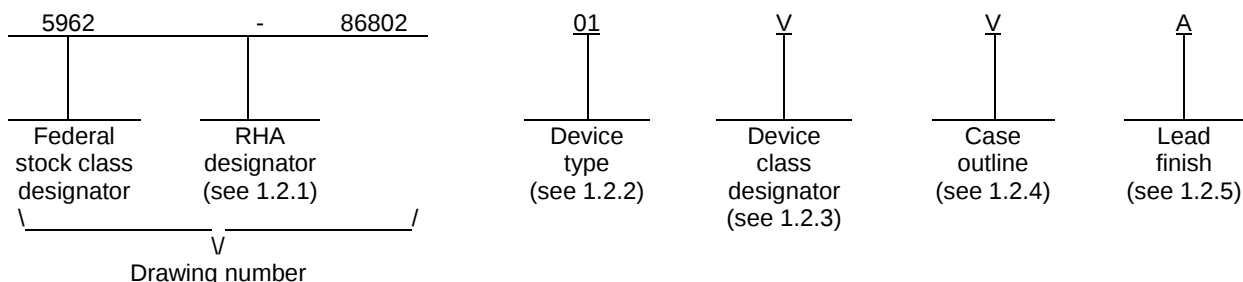
1.1 Scope. This drawing documents two product assurance class levels consisting of high reliability (device classes Q and M) and space application (device class V). A choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of Radiation Hardness Assurance (RHA) levels is reflected in the PIN.

1.2 PIN. The PIN is as shown in the following examples.

For device classes M and Q:



For device class V:



1.2.1 RHA designator. Device classes Q and V RHA marked devices meet the MIL-PRF-38535 specified RHA levels and are marked with the appropriate RHA designator. Device class M RHA marked devices meet the MIL-PRF-38535, appendix A specified RHA levels and are marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.

1.2.2 Device type(s). The device type(s) identify the circuit function as follows:

Device type	Generic number	Circuit function
01	AD570	8-bit A/D with three-state output
02	AD571	10-bit A/D with three-state output
03	AD571	10-bit A/D with three-state output

1.2.3 Device class designator. The device class designator is a single letter identifying the product assurance level as listed below. Since the device class designator has been added after the original issuance of this drawing, device classes M and Q designators will not be included in the PIN and will not be marked on the device.

Device class	Device requirements documentation
M	Vendor self-certification to the requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A
Q or V	Certification and qualification to MIL-PRF-38535

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-86802
		REVISION LEVEL E	SHEET 2

1.2.4 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
V	GDIP1-T18 or CDIP2-T18	18	Dual-in-line

1.2.5 Lead finish. The lead finish is as specified in MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

1.3 Absolute maximum ratings. 1/

Negative supply voltage (V_{EE}) to digital common	-16.5 V dc
Positive supply voltage (V_{CC}) to digital common	+7 V dc
Analog input voltage to analog common	± 15 V dc
Digital input voltage to digital common	0 V dc to V_{CC}
Digital output voltage to digital common	0 V dc to V_{CC}
Analog return to digital common	± 1 V dc
Power dissipation ($T_A = 25^\circ\text{C}$)	800 mW
Lead temperature (soldering, 10 seconds)	+300°C
Storage temperature range	-65°C to +150°C
Junction temperature (T_J)	+175°C
Thermal resistance, junction-to-case (θ_{JC})	See MIL-STD-1835
Thermal resistance, junction-to-ambient (θ_{JA})	+88°C/W

1.4 Recommended operating conditions.

Positive supply voltage range	+4.5 V dc to +5.5 V dc
Negative supply voltage range	-13.5 V dc to -16.0 V dc
Minimum high-level input voltage	+2.0 V dc
Maximum low-level input voltage	+0.8 V dc
Ambient operating temperature range (T_A)	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.
MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.
MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <https://assist.daps.dla.mil/quicksearch/> or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-86802
		REVISION LEVEL E	SHEET 3

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements for device classes Q and V shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. The individual item requirements for device class M shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein for device classes Q and V or MIL-PRF-38535, appendix A and herein for device class M.

3.2.1 Case outline. The case outline shall be in accordance with 1.2.4 herein .

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.3 Electrical performance characteristics and postirradiation parameter limits. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full ambient operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table IIA. The electrical tests for each subgroup are defined in table I.

3.5 Marking. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device. For RHA product using this option, the RHA designator shall still be marked. Marking for device classes Q and V shall be in accordance with MIL-PRF-38535. Marking for device class M shall be in accordance with MIL-PRF-38535, appendix A.

3.5.1 Certification/compliance mark. The certification mark for device classes Q and V shall be a "QML" or "Q" as required in MIL-PRF-38535. The compliance mark for device class M shall be a "C" as required in MIL-PRF-38535, appendix A.

3.6 Certificate of compliance. For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.6.1 herein). For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6.2 herein). The certificate of compliance submitted to DLA Land and Maritime-VA prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device classes Q and V, the requirements of MIL-PRF-38535 and herein or for device class M, the requirements of MIL-PRF-38535, appendix A and herein.

3.7 Certificate of conformance. A certificate of conformance as required for device classes Q and V in MIL-PRF-38535 or for device class M in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change for device class M. For device class M, notification to DLA Land and Maritime-VA of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change that affects this drawing.

3.9 Verification and review for device class M. For device class M, DLA Land and Maritime, DLA Land and Maritime 's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

3.10 Microcircuit group assignment for device class M. Device class M devices covered by this drawing shall be in microcircuit group number 57 (see MIL-PRF-38535, appendix A).

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-86802
		REVISION LEVEL E	SHEET 4

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions <u>1/ 2/ 3/</u> -55°C ≤ T _A ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Relative accuracy	R _A	Unipolar and bipolar major transitions ±3 codes	1, 2, 3	01		±0.195	% of FS
			1	02, 03		±0.195	
			2, 3, 12	02, 03		±0.098	
Digital input high voltage	V _{IH}	BLK and $\overline{\text{CONV}}$	1, 2, 3	All	2.0		V
Digital input low voltage	V _{IL}	BLK and $\overline{\text{CONV}}$	1, 2, 3	All		0.8	V
Digital input high current	I _{IH}	BLK and $\overline{\text{CONV}}$, V _{IH} = 5 V	1, 2, 3	All		±100	μA
Digital input low current	I _{IL}	BLK and $\overline{\text{CONV}}$, V _{IL} = 0 V	1, 2, 3	All		±100	μA
Digital output low voltage	V _{OL}	$\overline{\text{DATA READY}}$, bit 1 – 8, I _{OL} = +3.2 mA	1, 2, 3	01		0.4	V
		$\overline{\text{DATA READY}}$, bit 1 – 10, I _{OL} = +3.2 mA		02, 03		0.4	
Digital output high voltage	V _{OH}	Bit 1 – 8, I _{OH} = -0.5 mA	1, 2, 3	01	2.4		V
		Bit 1 – 10, I _{OH} = -0.5 mA		02, 03	2.4		
Full scale error <u>4/</u>	A _E	Unipolar	1	All		±40	mV
		Bipolar				±20	
Full scale temperature drift	TCA _E		2, 3	01		±0.781	% of FS
				02, 03		±0.488	
Offset error	V _{OS}	First transition	1	01, 02		±20	mV
			12	02		±10	
			12	03		±20	
Offset temperature drift	TCV _{OS}		2, 3	01		±0.391	% of FS
				02, 03		±0.195	
Bipolar zero error	B _{PZE}	Low side MSB, transition bipolar	1	All		±20	mV
			12	02, 03		±10	
Bipolar zero temperature	TCB _{PZE}	Bipolar	2, 3	01		±0.391	% of FS
				02, 03		±0.195	
Three-state leakage current	I _{OLT}	V _{OH} = 5 V, V _{OL} = 0 V, bit 1 - 8	1, 2, 3	01		±40	μA
		V _{OH} = 5 V, V _{OL} = 0 V, bit 1 - 10		02, 03		±40	
Power supply current	I _{CC}	$\overline{\text{CONV}}$, T _A = +25°C	1	All		10	mA
		BLK, T _A = +25°C				10	
	I _{EE}	T _A = +25°C				-15	

See footnotes at end of table.

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

REVISION LEVEL
E

5962-86802

SHEET
5

TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions <u>1/ 2/ 3/</u> $-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Differential nonlinearity <u>5/</u>	DNL	All codes test unipolar and bipolar	1, 2, 3	01	8		Bits
			1	02	8		
			2, 3, 12	02, 03	10		
Power supply rejection	PSRR	$-16.0\text{ V} \leq V_{EE} \leq -13.5\text{ V}$, $V_{CC} = +5\text{ V}$	1	01, 02		± 78.1	mV
			12	02, 03		± 19.5	
		$+4.5\text{ V} \leq V_{CC} \leq +5.5\text{ V}$, $V_{EE} = -15\text{ V}$	2, 3	All		± 78.1	
Input resistance	R_{IN}		4, 5, 6	All	3	7	k Ω
Conversion time	T_C	See figure 2, $T_A = +25^{\circ}\text{C}$	9	All	15	40	μs

1/ $V_{CC} = +5\text{ V}$, $V_{EE} = -15\text{ V}$, $V_{IH} = +2.0\text{ V}$, $V_{IL} = +0.8\text{ V}$, analog input through $15\text{ }\Omega$ to pin 13, unipolar configuration. Also, in the unipolar configuration pin 15 (bipolar offset control) is grounded.

2/ For device type 01 – One least significant bit (1 LSB) = 0.391% of Full Scale.

3/ For device types 02 and 03 – One least significant bit (1 LSB) = 0.098% of Full Scale.

4/ For device type 01 – Full scale error guaranteed trimmable with $200\text{ }\Omega$ potentiometer. For device types 02 and 03 – Full scale error guaranteed trimmable with $50\text{ }\Omega$ potentiometer.

5/ Minimum resolution for which no missing codes are guaranteed.

4. VERIFICATION

4.1 Sampling and inspection. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. For device class M, sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. For device classes Q and V, screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection.

4.2.1 Additional criteria for device class M.

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015.

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table IIA herein.

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

REVISION LEVEL
E

5962-86802

SHEET
6

Device types	01	02, 03
Case outline	V	
Terminal number	Terminal symbol	
1	NC	BIT 9
2	BIT 8	BIT 8
3	BIT 7	BIT 7
4	BIT 6	BIT 6
5	BIT 5	BIT 5
6	BIT 4	BIT 4
7	BIT 3	BIT 3
8	BIT 2	BIT 2
9	MSB BIT 1	MSB BIT 1
10	V _{CC}	V _{CC}
11	BLK and $\overline{\text{CONV}}$	BLK and $\overline{\text{CONV}}$
12	V _{EE}	V _{EE}
13	ANALOG IN	ANALOG IN
14	ANALOG COM	ANALOG COM
15	BIPOLAR OFF	BIPOLAR OFF
16	DIGITAL COM	DIGITAL COM
17	DATA READY	DATA READY
18	NC	BIT 10 LSB

FIGURE 1. Terminal connections.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-86802
		REVISION LEVEL E	SHEET 7

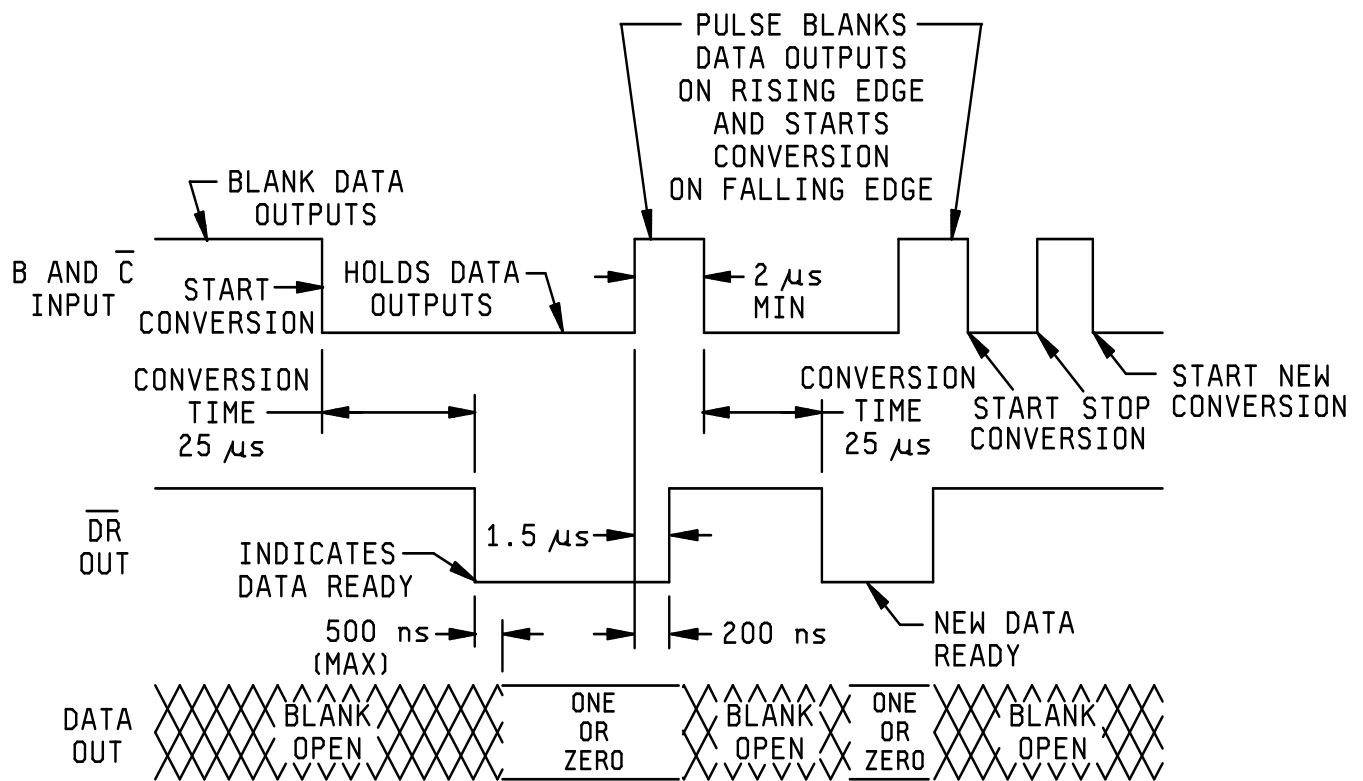


FIGURE 2. Timing waveforms.

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

REVISION LEVEL
E

5962-86802

SHEET
8

4.2.2 Additional criteria for device classes Q and V.

- a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
- b. Interim and final electrical test parameters shall be as specified in table IIA herein.
- c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in MIL-PRF-38535, appendix B.

4.3 Qualification inspection for device classes Q and V. Qualification inspection for device classes Q and V shall be in accordance with MIL-PRF-38535. Inspections to be performed shall be those specified in MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

4.4 Conformance inspection. Technology conformance inspection for classes Q and V shall be in accordance with MIL-PRF-38535 including groups A, B, C, D, and E inspections and as specified. Quality conformance inspection for device class M shall be in accordance with MIL-PRF-38535, appendix A and as specified herein. Inspections to be performed for device class M shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

4.4.1 Group A inspection.

- a. Tests shall be as specified in table IIA herein.
- b. Subgroups 7, 8, 10, and 11 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Special subgroup 12 added for grading and selection at +25°C.

4.4.2 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table IIA herein.

4.4.2.1 Additional criteria for device class M. Steady-state life test conditions, method 1005 of MIL-STD-883:

- a. Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
- b. $T_A = +125^\circ\text{C}$, minimum.
- c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

4.4.2.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-86802
		REVISION LEVEL E	SHEET 9

TABLE IIA. Electrical test requirements.

Test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)	Subgroups (in accordance with MIL-PRF-38535, table III)	
	Device class M	Device class Q	Device class V
Interim electrical parameters (see 4.2)	1	1	1
Final electrical parameters (see 4.2)	1, 2, 3, 4, 9, 12 <u>1/</u>	1, 2, 3, 4, 9, 12 <u>1/</u>	1, 2, 3, 4, 9, 12 <u>1/ 2/</u>
Group A test requirements (see 4.4)	1, 2, 3, 4, 5, 6, 9, 12	1, 2, 3, 4, 5, 6, 9, 12	1, 2, 3, 4, 5, 6, 9, 12
Group C end-point electrical parameters (see 4.4)	1	1	1 <u>2/</u>
Group D end-point electrical parameters (see 4.4)	1	1	1
Group E end-point electrical parameters (see 4.4)	---	---	---

1/ PDA applies to subgroup 1.

2/ Delta limits as specified in table IIB shall be required where specified and the delta limits shall be computed with reference to the previous interim electrical parameters.

TABLE IIB. Burn-in and operating life test delta parameters. $T_A = +25^{\circ}\text{C}$

Test	Delta		EOL Limits		Units
	Min	Max	Min	Max	
UZE	-1.5	1.5	-2.5	2.5	LSB
BZE	-2.0	2.0	-3.0	3.0	LSB
BIP -VFSE	-4.5	4.5	-8.2	8.2	LSB
UNI +VSFE	-4.5	4.5	-8.2	8.2	LSB
BIP +VFSE	-4.5	4.5	-8.2	8.2	LSB

4.4.3 Group D inspection. The group D inspection end-point electrical parameters shall be as specified in table IIA herein.

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

REVISION LEVEL
E

5962-86802

SHEET
10

4.4.4 Group E inspection. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein).

- a. End-point electrical parameters shall be as specified in table IIA herein.
- b. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535 for the RHA level being tested. For device class M, the devices shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535, appendix A for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at $T_A = +25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, after exposure, to the subgroups specified in table IIA herein.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.1.1 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.2 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.3 Record of users. Military and industrial users should inform DLA Land and Maritime when a system application requires configuration control and which SMD's are applicable to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DLA Land and Maritime-VA, telephone (614) 692-0544.

6.4 Comments. Comments on this drawing should be directed to DLA Land and Maritime-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0540.

6.5 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331.

6.6 Sources of supply.

6.6.1 Sources of supply for device classes Q and V. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DLA Land and Maritime-VA and have agreed to this drawing.

6.6.2 Approved sources of supply for device class M. Approved sources of supply for class M are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DLA Land and Maritime-VA.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-86802
		REVISION LEVEL E	SHEET 11

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 10-10-20

Approved sources of supply for SMD 5962-86802 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime -VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DLA Land and Maritime maintains an online database of all current sources of supply at <http://www.dsccl.dla.mil/Programs/Smcr/>.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-8680201VA	24355 (2)	AD570SD/883B
5962-8680202VA	24355 (2)	AD571SD/883B
5962-8680203VVA	24355 (4)	AD571SD/QMLV

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.
- 2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

Vendor name
and address

24355

Analog Devices (2)
RT 1 Industrial Park
PO Box 9106
Norwood, MA 02062
Point of contact: 804 Woburn Street
Wilmington, MA 01887-3462

24355

Analog Devices (4)
RT 1 Industrial Park
PO Box 9106
Norwood, MA 02062
Point of contact: 7910 Triad Center Drive
Greensboro, NC 27409-9605

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.